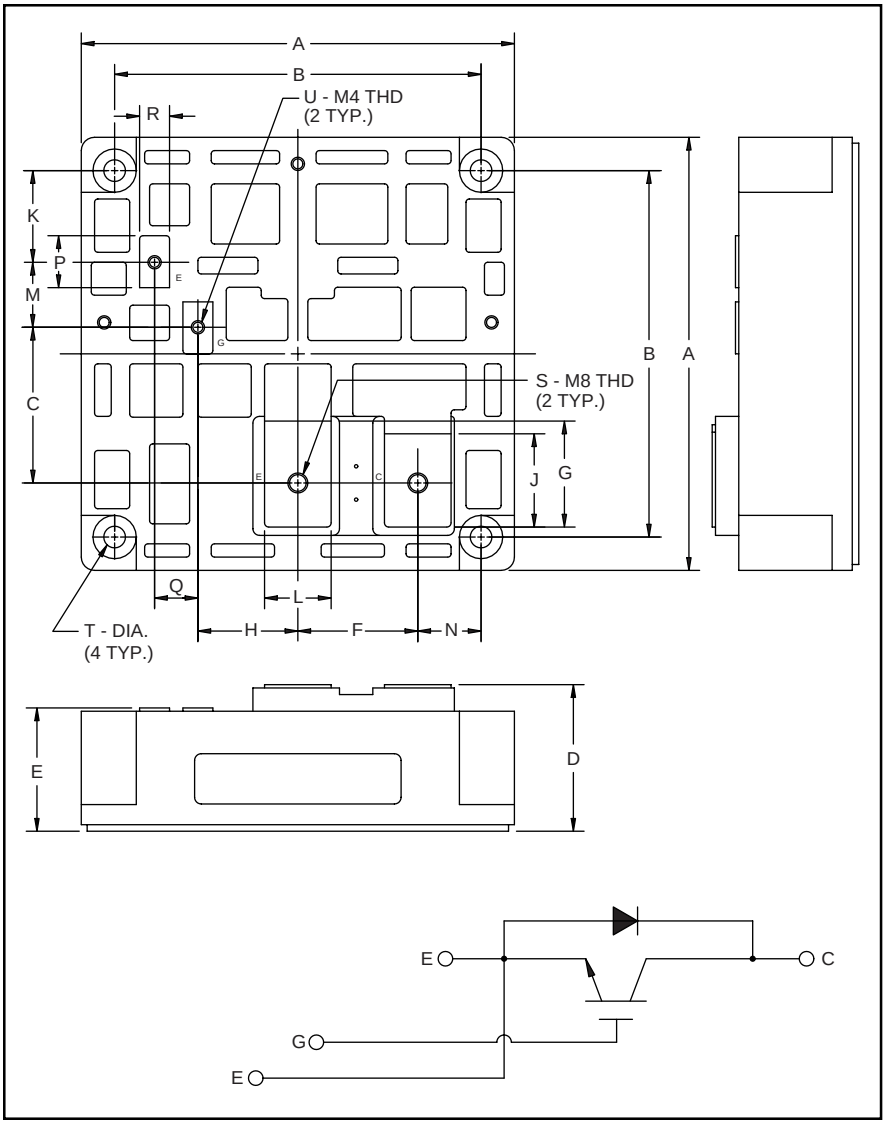
Powerex, Inc., 200 Hillis Street, Youngwood, Pennsylvania 15697-1800 (724) 925-7272

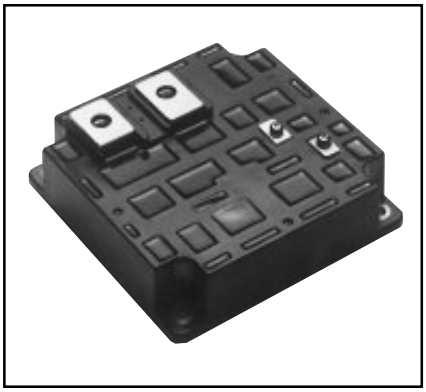
Single IGBTMOD™ H-Series Module
800 Amperes/1200 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	5.12	130.0
B	4.33±0.01	110.0±0.25
C	1.840	46.75
D	1.73±0.04/0.02	44.0±1.0/0.5
E	1.46±0.04/0.02	37.0±1.0/0.5
F	1.42	36.0
G	1.25	31.8
H	1.18	30.0
J	1.10	28.0
K	1.08	27.5

Dimensions	Inches	Millimeters
L	0.79	20.0
M	0.77	19.5
N	0.75	19.0
P	0.61	15.6
Q	0.51	13.0
R	0.35	9.0
S	M8 Metric	M8
T	0.26 Dia.	Dia. 6.5
U	M4 Metric	M4



Description:
Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of one IGBT Transistor in a single configuration with a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:
- ☐ Low Drive Power
- ☐ Low $V_{CE(sat)}$
- ☐ Discrete Super-Fast Recovery (135ns) Free-Wheel Diode
- ☐ High Frequency Operation (20-25kHz)
- ☐ Isolated Baseplate for Easy Heat Sinking

Applications:
- ☐ AC Motor Control
- ☐ Motion/Servo Control
- ☐ UPS
- ☐ Welding Power Supplies
- ☐ Laser Power Supplies

Ordering Information:
Example: Select the complete part module number you desire from the table below -i.e. CM800HA-24H is a 1200V (V_{CES}), 800 Ampere Single IGBTMOD™ Power Module.

Type	Current Rating Amperes	V_{CES} Volts (x 50)
CM	800	24

CM800HA-24H
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Absolute Maximum Ratings, T_j = 25 °C unless otherwise specified

Ratings	Symbol	CM800HA-24H	Units
Junction Temperature	T_j	–40 to +150	°C
Storage Temperature	T_{stg}	–40 to +125	°C
Collector-Emitter Voltage (G-E SHORT)	V_{CES}	1200	Volts
Gate-Emitter Voltage	V_{GES}	±20	Volts
Collector Current	I_C	800	Amperes
Peak Collector Current	I_{CM}	1600*	Amperes
Diode Forward Current	I_F	800	Amperes
Diode Forward Surge Current	I_{FM}	1600*	Amperes
Power Dissipation	P_d	4800	Watts
Max. Mounting Torque M8 Terminal Screws	–	95	in-lb
Max. Mounting Torque M6 Mounting Screws	–	26	in-lb
Max. Mounting Torque M4 G-E Terminal Screws	–	13	in-lb
Module Weight (Typical)	–	1600	Grams
V Isolation	V_{RMS}	2500	Volts

* Pulse width and repetition rate should be such that device junction temperature does not exceed the device rating.

Static Electrical Characteristics, T_j = 25 °C unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	I_{CES}	$V_{CE} = V_{CES}$, V_{GE} = 0V	–	–	5.0	mA
Gate Leakage Current	I_{GES}	$V_{GE} = V_{GES}$, V_{CE} = 0V	–	–	0.5	μA
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	I_C = 80mA, V_{CE} = 10V	4.5	6.0	7.5	Volts
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	I_C = 800A, V_{GE} = 15V	–	2.7	3.6	Volts
		I_C = 800A, V_{GE} = 15V, T_j = 150°C	–	2.4	–	Volts
Total Gate Charge	Q_G	V_{CC} = 600V, I_C = 800A, V_{GS} = 15V	–	4500	–	nC
Diode Forward Voltage	V_{FM}	I_E = 800A, V_{GS} = 0V	–	–	3.5	Volts

* Pulse width and repetition rate should be such that device junction temperature rise is negligible.

Dynamic Electrical Characteristics, T_j = 25 °C unless otherwise specified

Characteristics		Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance		C_{ies}	V_{GE} = 0V, V_{CE} = 10V, f = 1MHz	–	–	180	nF
Output Capacitance		C_{oes}		–	–	64	nF
Reverse Transfer Capacitance		C_{res}		–	–	36	nF
Resistive	Turn-on Delay Time	$t_{d(on)}$	V_{CC} = 600V, I_C = 800A, $V_{GE1} = V_{GE2}$ = 15V, R_G = 4.2Ω	–	–	500	ns
Load	Rise Time	t_r		–	–	1200	ns
Switching	Turn-off Delay Time	$t_{d(off)}$		–	–	1000	ns
Times	Fall Time	t_f		–	–	350	ns
Diode Reverse Recovery Time		t_{rr}	I_E = 800A, di_E/dt = –1600A/μs	–	–	250	ns
Diode Reverse Recovery Charge		Q_{rr}	I_E = 800A, di_E/dt = –1600A/μs	–	5.9	–	μC

Thermal and Mechanical Characteristics, T_j = 25 °C unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{th(j-c)}$	Per IGBT	–	–	0.026	°C/W
Thermal Resistance, Junction to Case	$R_{th(j-c)}$	Per FWDi	–	–	0.058	°C/W
Contact Thermal Resistance	$R_{th(c-f)}$	Per Module, Thermal Grease Applied	–	–	0.018	°C/W

CM800HA-24H
Single IGBTMOD™ H-Series Module
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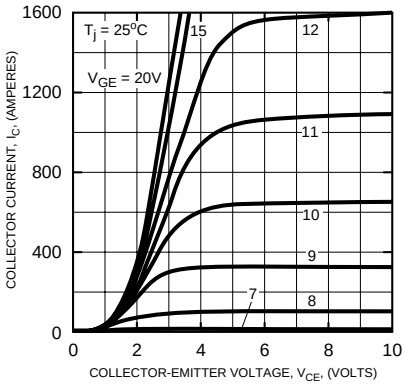
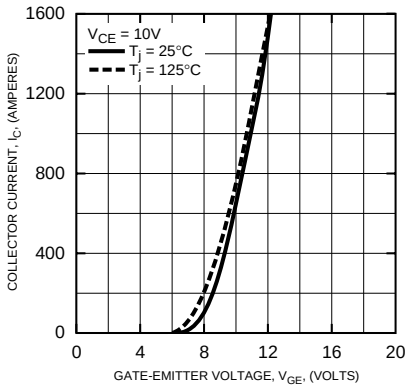
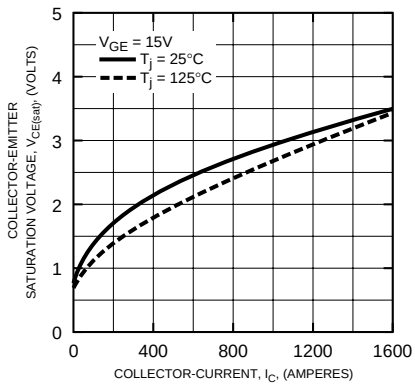
OUTPUT CHARACTERISTICS (TYPICAL)



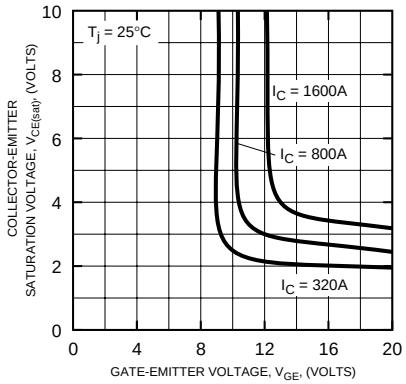
TRANSFER CHARACTERISTICS (TYPICAL)



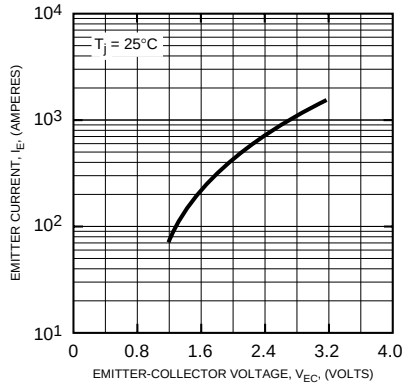
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



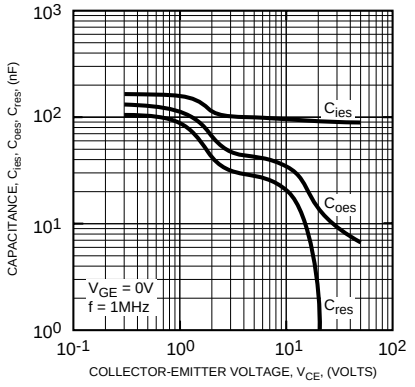
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



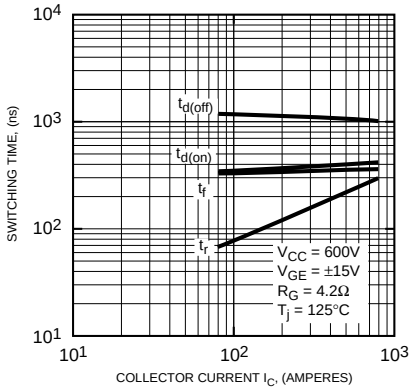
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



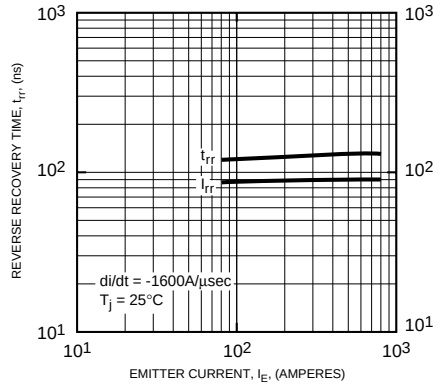
CAPACITANCE VS. V_{CE} (TYPICAL)



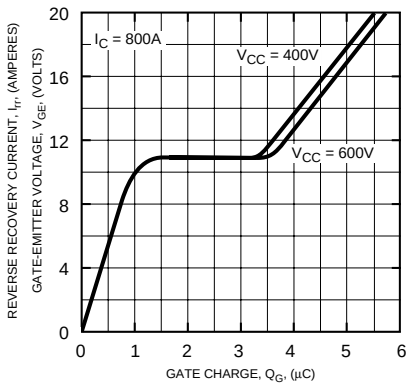
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)



REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



GATE CHARGE, V_{GE}



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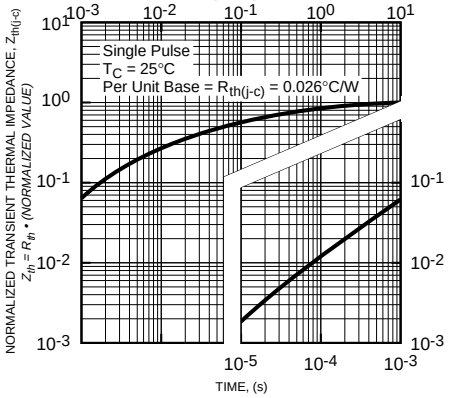
TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (IGBT)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (FWDi)